Temperature Performance of GaInNAs-Based Photonic Crystal Waveguide Modulators

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Abstract—The temperature performances of GaInNAs-based semiconductor devices, for next generation communication networks and photonic integrated circuits, are investigated. In particular, GaInNAs-GaInAs Multi Quantum Well active ridge waveguides, patterned with a periodic one-dimensional grating and an active defective region placed in the central layer, have been designed for efficient active optical switches and modulators. The switching mechanism was obtained around the Bragg wavelength \( \lambda \approx 1.2896 \mu \text{m} \) at room temperature \( T = 298 \text{ K} \) by properly designing the periodic grating and changing the injected current density from \( J_{\text{OFF}} = 0 \text{ mA/\mu m}^2 \) to \( J_{\text{ON}} = 0.496 \text{ mA/\mu m}^2 \). The proposed device exhibits high performances in terms of crosstalk, contrast ratio, and modulation depth. The temperature performance of the proposed device is analyzed in the range \( T = 298 \text{ K} - 400 \text{ K} \), showing a good stability of the figures of merit: crosstalk CT, contrast ratio CR, and bandwidth \( \Delta \lambda \). In particular, the CT varies at about 1.2 dB in the whole temperature range, whereas CR and \( \Delta \lambda \) experience, respectively, a maximum variation of 25% and 30% of their maximum values.

1. INTRODUCTION

The need of innovative devices, which can guarantee low-cost and low power-budget operation together with high transmission performances, is becoming more and more urgent in telecommunication networks. A major challenge is the achievement of a stable temperature operation not only for laser sources, but also for modulators, switches and routing devices. In particular, photonic integrated networks would benefit the cooler-less operation either for the overall power budget or for the stability of resonance based devices. This issue becomes particularly relevant in applications such as the photonic networks on chip (NoC) [1, 2]. These integrated networks are particularly promising to overcome the performance limitations of on-chip electrical networks, but their behavior is strongly affected by the temperature since the routing devices are generally based on resonance mechanisms which require precise tuning. The temperature constraint can be relieved by design approaches exploiting wide-band operating devices, by compensating the refractive index variation through the inclusion of suitable thermo-optic materials (e.g., negative thermo-optic polymers), or by external temperature stabilization with a non-negligible contribution on the overall power budget [3–6]. Similarly, medium distance and high density optical networks would indeed benefit of low-cost and low-power transmitters modules which can guarantee high bit-rate and stable performances.

In this context, active components based on novel material systems such as GaInNAs, also known as dilute nitrides, appear to be very attractive to achieve stable temperature operation [7, 8]. These materials realize very good electron confinement in the active region and, thanks to a large conduction band offset, lead to lasers with excellent high-temperature performance and uncooled operation in a wide temperature range (e.g., up to 110°C) [9–13]. Dilute nitrides proved advantageous in different applications in optical communication systems such as Semiconductor Optical Amplifiers (SOA) [14],
optical active switches [15], vertical-cavity surface-emitting lasers (VCSELs) [16], ridge lasers [17], and disk lasers [18].

This paper focuses on the temperature performance of GaInNAs-based semiconductor devices, for next generation communication networks and photonic integrated circuits. In particular, the temperature performance of an active one-dimensional Photonic Crystal (PhC) is investigated. The structure under study consists of a GaInNAs-GaInAs Multi Quantum Wells (MQW) ridge waveguide patterned with a periodic one-dimensional (1-D) grating, which behaves as a modulator by suitably changing the injected current in the active region. The device conjugates the dilute nitride properties to the capability of periodic structures of tailoring the light propagation. In fact, thanks to the induced photonic band gap (PBG), periodic structures can be exploited for the realization of optical devices such as waveguides, cavities, filters [19–22]. Moreover, the PBG devices are even more interesting when exploiting different material properties, e.g., in the case of liquid crystal infiltration or non-linear materials [23, 24], which allow the realization of efficient tunable filters and frequency converters. Moreover, they exhibit a more efficient interaction between the light and the active materials, thanks to their capability of reducing the group velocity at certain wavelengths [25, 26].

Here, we investigate the temperature behavior of periodic waveguiding structures, that we previously proposed at ambient temperature [15, 27–29], for modulation applications in the second window of the fiber optics telecommunications. For this purpose, the numerical model of the active material as a function of temperature is introduced in the Bidirectional Beam Propagation Method based on Method of Lines (MoL-BBPM) simulations.

2. BRIEF THEORY

To account for the interaction of the injected current with the electronic structure of Ga_{0.77}In_{0.23}N_{0.03}As_{0.97}/Ga_{0.8}In_{0.2}As QWs, the rate equations have been introduced. In particular, the following stationary expression is applied [26, 29]:

\[ D_e \nabla^2 \sigma(x, y, z) = - \frac{J(z)}{e d_a} + \frac{g_m(x, y, z, \sigma)}{e h v} \Gamma |E(x, y, z)|^2 + A \sigma + B \sigma^2 + C \sigma^3. \]  

(1)

where \( \sigma(x, y, z) \) is the charge density distribution; \( d_a \) is the active layer thickness; \( |E(x, y, z)| \) is the electric field modulus; \( h = 6.626 \times 10^{-34} \text{ J s} \) is the Planck constant; \( e = 1.602 \times 10^{-19} \text{ C} \) is the electron charge; the product \( h v \) is the photon energy expressed in eV; \( J \) is the injected current density; \( \Gamma = 0.044 \) is the optical confinement factor. Moreover, \( A = 2 \times 10^8 \text{ s}^{-1} \), \( B = 7 \times 10^{-17} \text{ m}^3 \text{s}^{-1} \), \( C = 4 \times 10^{-41} \text{ m}^6 \text{s}^{-1} \) are the non-radiative, radiative, and Auger recombination coefficients, respectively; \( D_e = 0.001 \text{ m}^2 \text{s}^{-1} \) is the diffusion coefficient. The material gain \( g_m(x, y, z, \sigma, \lambda, T) \), which depends on the spatial coordinates \( x, y, z \), the carrier density \( \sigma \), the wavelength \( \lambda \), and the temperature \( T \), has been evaluated in the context of Fermi’s Golden Rule (FGR) accounting for intraband effects through a Lorentzian broadening function. The conduction band electronic states, involved in the calculation of the material gain, are given by the Band Anticrossing Model that accounts for N-induced nonparabolicity of the conduction band, whereas the valence band states are described by a \( 6 \times 6 \) LK Hamiltonian. Strain effects are described using the Pikus-Bir Hamiltonian. The gain and bandstructure calculations including strain effects follow the formalism of [30–33]. The temperature influence on the bandgap of the semiconductor structure is accounted for the following expression [34]:

\[ E_g(x, T) = 0.42 + 0.625 x - \left( \frac{5.8}{T + 300} - \frac{4.19}{T + 273} \right) 10^{-3} T^2 x - \frac{4.19 \cdot 10^{-4}}{T + 271} + 0.475 x^2. \]  

(2)

derived for the bandgap calculation of the matrix semiconductor Ga_{x}In_{1-x}As.

In the rate Equation (1) the propagating electric field \( E \) has been calculated by implementing an appropriate version of the MoL-BBPM [35–37]. It allows for accounting the electromagnetic (EM) field along the structure by means of a step by step propagation technique, thus allowing for the injection current in the active layers. Moreover, in presence of dielectric discontinuity this algorithm solves both the forward \((+z)\) and the backward \((-z)\) propagations along the longitudinal \( z \) direction of the waveguiding structure. The MoL-BBPM procedure, applied iteratively by evaluating the whole electromagnetic field in the structure, stops when the change of the electromagnetic field, at the generic \( i \)-th iteration, in the output section is less than a given tolerance \( \varepsilon \) [26]: \((E_i - E_{i-1})/E_i < \varepsilon\).
The influence of the active layer of Ga$_{0.77}$In$_{0.23}$N$_{0.03}$As$_{0.97}$/Ga$_{0.8}$In$_{0.2}$As QWs on the MoL-BBPM propagation solver is accounted for by considering in the iterations the updated values of the complex refractive index \( n_a(x, y, z) \) in the active layer given by [38]:

\[
n_a(x, y, z) = n_p + \beta_e \sigma(x, y, z) + \frac{jg_m(x, y, z, \sigma, \lambda, T)}{2k_0}
\]

where \( n_p \) is the refractive index of the active medium in the absence of charge injection, \( k_0 \) the vacuum wavenumber, and \( \beta_e = -1.8 \cdot 10^{-26} \text{cm}^3 \) the anti-guide coefficient. So, the rate Equation (1) and the MoL-BBPM solver must be contemporary applied to give the self-consistent solution of the EM field along the structure.

To simplify the complexity of the numerical model, the three-dimensional structure was reduced to a two-dimensional one by the Refractive Effective Index Method (REIM) [39, 40]. The REIM is an approximation technique widely adopted to evaluate the propagation constants and the electromagnetic field distributions in dielectric waveguides. The REIM has been extensively demonstrated to agree well with analytical solutions and with other bi-dimensional and three-dimensional numerical methods (i.e., Finite Element Method, mode-matching, etc.) [39–42]. The REIM allows us to solve the wave equation in a simplified form. Accordingly, the three-dimensional structure was reduced to a two-dimensional one, in which the core refractive index is replaced by the temporary effective refractive index (calculated considering the waveguide stratified along the \( y \)-direction). The obtained two-dimensional waveguide is, therefore, discretized along the \( x \) direction and the propagation is obtained by solving the wave equation, together with the rate equation, along the longitudinal direction \( z \) according to the BBPM-MoL method.

3. TEMPERATURE PERFORMANCE OF A DILUTE NITRIDE OPTICAL AMPLIFIER (DNOA)

The temperature change strongly influences the material gain characteristics. In fact, temperature primarily affects the energy bandgap and, then, the energy band-structure. The changes in the energy band-structure due to the temperature fluctuations induce changes on the material optical properties through the Fermi’s Golden rule.

Preliminary, we evaluate the influence of the temperature on the performances of a Dilute Nitride Optical Amplifier (DNOA). Fig. 1 sketches the examined DNOA made of an active ridge waveguide, the core of which is made of four Ga$_{0.77}$In$_{0.23}$N$_{0.03}$As$_{0.97}$ quantum wells (QWs) with refractive index \( n_{\text{GaInNAs}} = 3.65 \) and thickness \( d_{\text{GaInNAs}} = 7 \text{ nm} \), with Ga$_{0.8}$In$_{0.2}$As barrier layers having refractive index \( n_{\text{GaInAs}} = 3.47 \) and thickness \( d_{\text{GaInAs}} = 16.5 \text{ nm} \). This particular QW arrangement exhibits polarization insensitive performance [43]. The ridge waveguide is characterized by the following geometrical and physical parameters at the operating wavelength \( \lambda_B = 1.2888 \mu\text{m} \): active core with thickness \( d_c = 110.5 \text{ nm} \), cladding layer with refractive index \( n_{\text{AlGaAs}} = 3.285 \) and thickness \( d_{\text{cl}} = 0.220 \mu\text{m} \), ridge height \( h_2=1.0 \mu\text{m} \), and ridge width \( w = 2 \mu\text{m} \). The thickness of the AlGaAs substrate has been suitably chosen to apply appropriate voltage values at the metallic contacts and to obtain the desired values of the injected current \( I \) in the active region.

In Fig. 2(a) we report the calculated patterns of the material gain \( g_m \) of the four GaInNAs-GaInAs QWs as a function of the carrier density \( \sigma \) for a fixed value of the wavelength \( \lambda = 1.2888 \mu\text{m} \) and for different temperature values in the range \( T = 298 \text{K–390K} \). We can see that, for all the values of the examined temperature range, \( g_m \) assumes an increasing trend with increasing \( \sigma \). For \( \sigma \) greater than about 5-10$^{24}$ m$^{-3}$ the slopes of the curves decreases and the material gain \( g_m \) tends to assume a constant value (gain saturation effect). In addition, Fig. 2(b) illustrates the $g_m - \lambda$ curves for different temperature values in the range \( T = 298 \text{K–390K} \), for a fixed value of the carrier density \( \sigma = 8 \cdot 10^{24} \text{ m}^{-3} \). We can see that the curves show peaks of the material gain for wavelength values \( \lambda_p \) in the range \( \lambda_p = 1.28 \mu\text{m}–1.32 \mu\text{m} \) by increasing the temperature from \( T = 298 \text{K} \) to \( T = 400 \text{K} \), whereas, correspondingly, the \( g_{mp} \) peak value decreases. The findings of Fig. 2(b) in terms of the peak of the material gain \( g_{mp} \) and the corresponding wavelength value \( \lambda_p \) for the different temperature values in the range \( T = 298 \text{K–390K} \) are summarized in Table 1. As expected, by increasing the temperature from \( T = 298 \text{K} \) to \( T = 390 \text{K} \), \( g_{mp} \) decreases from 3.81 \cdot 10^5 \text{ m}^{-1} \) to 3.21 \cdot 10^5 \text{ m}^{-1} \), and correspondingly, the peak wavelength \( \lambda_p \) shifts towards greater values increasing from 1.2759 \mu\text{m} \) to 1.3110 \mu\text{m}. 

Figure 1. Scheme of the ridge waveguide DNOA. The core is made of four Ga\(_{0.77}\)In\(_{0.23}\)N\(_{0.03}\)As\(_{0.97}\) quantum wells and five Ga\(_{0.8}\)In\(_{0.2}\)As barrier layers.

Figure 2. Calculated material gain as a function of (a) the carrier density \(\sigma\) for the wavelength \(\lambda = 1.2888\,\mu\text{m}\) and of (b) the wavelength \(\lambda\) for the carrier density \(\sigma = 8 \cdot 10^{24}\,\text{m}^{-3}\).

Table 1. Values of the peak of the material gain \(g_{mp}\) and the corresponding wavelength \(\lambda_p\) as a function of the temperature \(T\) for constant carrier density \(\sigma = 8 \cdot 10^{24}\,\text{m}^{-3}\).

<table>
<thead>
<tr>
<th>(T) [K]</th>
<th>(\lambda_p) [(\mu\text{m})]</th>
<th>(g_{mp}) [m(^{-1})]</th>
</tr>
</thead>
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<tr>
<td>298</td>
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<td>3.81 \cdot 10^5</td>
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<tr>
<td>310</td>
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<td>3.46 \cdot 10^5</td>
</tr>
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<td>370</td>
<td>1.3015</td>
<td>3.33 \cdot 10^5</td>
</tr>
<tr>
<td>390</td>
<td>1.3110</td>
<td>3.21 \cdot 10^5</td>
</tr>
</tbody>
</table>

Figure 3 shows the material gain changes with temperature for the wavelength \(\lambda = 1.2888\,\mu\text{m}\) for four values of the carrier density \(\sigma = 3 \cdot 10^{24}\,\text{m}^{-3}\) (solid line), \(\sigma = 5 \cdot 10^{24}\,\text{m}^{-3}\) (dashed line), \(\sigma = 8 \cdot 10^{24}\,\text{m}^{-3}\) (dotted line) and \(\sigma = 18 \cdot 10^{24}\,\text{m}^{-3}\) (dash-dotted line). For \(\sigma = 3 \cdot 10^{24}\,\text{m}^{-3}\) the material gain assumes negative values for temperature greater than 325 K for which the absorption effect becomes prevalent with respect to the gain. For greater \(\sigma\) values the gain is always positive for all the temperature values in the range \(T = 298\,\text{K} – 400\,\text{K}\). Moreover, for \(\sigma \geq 5 \cdot 10^{24}\,\text{m}^{-3}\) the curves show a
maximum value of the material gain $g_{\text{mMax}}$ and, in particular, we have calculated: for $\sigma = 5 \cdot 10^{24} \text{ m}^{-3}$ $g_{\text{mMax}} = 1.82 \cdot 10^5 \text{ m}^{-1}$ at temperature $T = 308 \text{ K}$, for $\sigma = 8 \cdot 10^{24} \text{ m}^{-3}$ $g_{\text{mMax}} = 3.63 \cdot 10^5 \text{ m}^{-1}$ at $T = 318 \text{ K}$ and for $\sigma = 18 \cdot 10^{24} \text{ m}^{-3}$ $g_{\text{mMax}} = 6.72 \cdot 10^5 \text{ m}^{-1}$ at $T = 322 \text{ K}$.

The knowledge of the material gain dependence with the temperature allows for the evaluation of the influence of the temperature on the performance of the ridge waveguide 4-QW DNOA of Fig. 1 in the case of amplifier length $L_{\text{tot}} = 130 \mu\text{m}$. The simulations have been carried out by means of the MoL-BBPM in which the four QW active layer is accounted for by the complex value of the refractive index $n_a$ of Equation (3). Fig. 4(a) reports the gain $G_{\text{DNOA}}$ of the DNOA as a function of the injected current density for different values of the temperature in the range $T = 298 \text{ K} - 390 \text{ K}$. Obviously, for each temperature value the gain assumes an increasing behaviour with the injected current density by passing from negative to positive values with respect to the transparency injected current density $J_{\text{tr}}$ for which $G_{\text{DNOA}} = 0 \text{ dB}$. We can see that, by increasing the temperature from $T = 298 \text{ K}$ to $T = 390 \text{ K}$, the curves show lower $G_{\text{DNOA}}$ values. In addition, by inspection of Fig. 4(b), the transparency current density $J_{\text{tr}}$ increases with the temperature. In particular, by changing the temperature from 298 K to 400 K, a gain of the DNOA greater than 0 dB can be obtained for injected current values greater than $J_{\text{tr}} = 0.08 \text{ mA/\mu m}^2$ and $J_{\text{tr}} = 0.21 \text{ mA/\mu m}^2$, respectively, thus drastically increasing the transparency current density value.

**Figure 3.** Material gain $g_{\text{m}}$ as a function of the temperature ranging from to 298 K to 400 K for $\lambda = 1.2888 \mu\text{m}$ for four different values of the carrier density: $\sigma = 3 \cdot 10^{24} \text{ m}^{-3}$ (solid line), $\sigma = 5 \cdot 10^{24} \text{ m}^{-3}$ (dashed line), $\sigma = 8 \cdot 10^{24} \text{ m}^{-3}$ (dotted line) and $\sigma = 18 \cdot 10^{24} \text{ m}^{-3}$ (dash-dotted line).

**Figure 4.** (a) Calculated gain $G_{\text{DNOA}}$ of the ridge waveguide 4-QW DNOA as a function of the injected current density $J$ for different temperature values in the range $T = 298 \text{ K} - 390 \text{ K}$. The horizontal thin solid line for the constant value $G_{\text{DNOA}} = 0 \text{ dB}$ put in evidence the transparency condition for the current density. (b) Transparency current density $J_{\text{tr}}$ as a function of the temperature.
4. DILUTE NITRIDE 1-D RIDGE WAVEGUIDE PHOTONIC CRYSTAL AS ACTIVE MODULATOR

By exploiting the properties of the proposed GaInNAs-GaInAs 4-MQW ridge amplifier, we can design a novel active modulator that exhibits high performance in terms of crosstalk, contrast ratio, modulation depth and bandwidth. Fig. 5 shows the sketch of the designed photonic crystal structure patterned with an one-dimensional (1-D) grating having \( N = 1243 \) alternating ridge waveguide layers. In particular, as shown in Fig. 5, the grating unit cell is made of two ridge waveguides having different values of the ridge heights \( h_1 \) and \( h_2 \), and of the ridge lengths \( l_1 \) and \( l_2 \). More precisely, for the first ridge waveguide we have \( h_1 = 0.10 \mu m \) and \( l_1 = 0.12 \mu m \), whereas for the second one \( h_2 = 1.0 \mu m \) and \( l_2 = 0.076 \mu m \), respectively. These geometrical parameters have been chosen to assure the PBG around the Bragg wavelength at \( \lambda_B = 1.2888 \mu m \).

A defect is introduced in the 1-D photonic crystal by changing in the central 622-th layer the corresponding ridge waveguide length from \( l_2 \) to \( L_z \) and by injecting current \( I \) through the electrode placed only on the defective active region.

The switching mechanism from the OFF-state to the ON-state can be obtained by properly choosing the defect length such that the wavelength \( \lambda_{\text{min}} \) of the minimum transmittance calculated without injecting current (passive case) coincides with that \( \lambda_{\text{Max}} \) of the maximum transmittance when the current is injected (active case). It is feasible because, by changing the defect length \( L_z \), the transmittance maximum shifts within the wavelength range delimited by the two band-edges of the periodic grating evaluated without defect [15]. In addition, similar behaviour occurs in the active case by changing the value of the injected current.

Figure 6 shows the spectra of the transmittance of the 1-D ridge waveguide grating with defect length \( L_z = 9.07 \mu m \) in the passive case (\( J_{\text{OFF}} = 0 \) mA/\( \mu m^2 \), dashed curve) and in the active case (\( J_{\text{ON}} = 0.496 \) mA/\( \mu m^2 \), solid curve).

The transmittance \( T \) is calculated according to the following definition, both in the active and passive cases:

\[
T = \frac{I_T}{I_{IN}}
\]
where \( I_T \) is the intensity of the optical field transmitted at the output port and \( I_{IN} \) the intensity associated to the input signal. The intensities were calculated as:

\[
I_i = \int |E_i(x)|^2 dx
\]

where \( E_i \) is the electric field, and subscript \( i \) refers to the input, transmitted, and reflected waves. Owing to the amplification effect of the optical signal, due to the injection of current in the active region, the value of the transmittance \( T \) can be higher than unity.

A perfect coincidence of the value of the two wavelengths \( \lambda_{\text{min}} = \lambda_{\text{Max}} = 1.2896 \mu m \) can be achieved at room temperature \( T = 298 \text{ K} \) for a defect length \( L = 9.07 \mu m \) and for a value of the injection current density \( J_{ON} = 0.496 \text{ mA/\mu m}^2 \) (\( J_{ON} = 9 \text{ mA} \)). More precisely, the switching from the OFF- to the ON-state occurs at the wavelength value \( \lambda_{SW} = 1.2896 \mu m \) for which the transmittance, evaluated at the end face of the 1-D grating of Fig. 5, changes from \( T_{OFF} = 0.12 \) to \( T_{ON} = 2.84 \) by changing the injected current density from \( J_{OFF} = 0 \text{ mA/\mu m}^2 \) to \( J_{ON} = 0.496 \text{ mA/\mu m}^2 \).

The performance of the designed active modulator, can be quantified with the following figures-of-merit: the crosstalk \( \text{CT} = 10 \log (T_{OFF}/T_{ON}) \), the modulation depth \( \text{MD} = 1 - T_{OFF}/T_{ON} \), and the contrast ratio \( \text{CR} = T_{ON}/T_{OFF} \). With reference to the results of Fig. 6 we have calculated crosstalk \( \text{CT} = -13.6 \text{ dB} \), contrast ratio \( \text{CR} = 22.7 \), and modulation depth \( \text{MD} = 0.96 \) at \( T = 298 \text{ K} \). A further useful parameter is the bandwidth \( \Delta \lambda \) for which the crosstalk is less than \(-12 \text{ dB} \) around to \( \lambda_{SW} \). The calculated bandwidth value is \( \Delta \lambda = 0.57 \text{ nm} \).

Better performance can be achieved by slightly increasing the value of the injection current density in the ON-state to \( J_{ON} = 0.606 \text{ mA/\mu m}^2 \) (\( I_{ON} = 11 \text{ mA} \)). In this case the switching wavelength \( \lambda_{SW} = 1.2894 \mu m \) slightly shifts towards a lower value, even though the new transmittance value \( T_{ON} = 3.19 \) increases at about \( 12\% \). Now the merit figures at temperature \( T = 298 \text{ K} \) assume the following improved values: crosstalk \( \text{CT} = -14.2 \text{ dB} \), contrast ratio \( \text{CR} = 26.2 \), modulation depth \( \text{MD} = 0.96 \), and bandwidth \( \Delta \lambda = 0.67 \text{ nm} \).

5. MODULATOR PERFORMANCE UNDER TEMPERATURE INFLUENCE

Temperature increase strongly affects the switching characteristics. In fact, temperature primarily influences the energy bandgap and then the energy band-structure that directly impacts on the optical properties of the active layer through Fermi’s Golden rule.
Figure 7 reports the spectra of the transmittance of the 1-D ridge waveguide grating with defect length $L_z = 9.07 \mu m$ in both the passive ($J_{OFF} = 0 mA/\mu m^2$) and the active cases ($J_{ON}$) for the injection current density $J_{ON} = 0.496 mA/\mu m^2$ (a) and $J_{ON} = 0.606 mA/\mu m^2$ (b) for different values of the temperature ranging from $T = 298 K$ to $T = 390 K$. The coincidence of the minimum of the transmittance $T_{OFF}$ in the passive case with the maximum of the transmittance $T_{ON}$ in the active case occurs for all the temperature values at the switching wavelength $\lambda_{SW} = 1.2896 \mu m$ (vertical solid line in Fig. 7(a)) for $J_{ON} = 0.496 mA/\mu m^2$ and at $\lambda_{SW} = 1.2894 \mu m$ (vertical solid line in Fig. 7(b)) for $J_{ON} = 0.606 mA/\mu m^2$. In the active case the influence of the temperature is strongly evident. In fact, for both the examined $J_{ON}$ values the maximum transmittance values $T_{ON}$ primarily increases by increasing the temperature from $T = 298 K$ to $T = 330 K$ and then it decreases more and more for increasing $T$ values. In summary, by changing the temperature from $T = 298 K$ to $T = 390 K$ the maximum transmittance reduces from $T_{ON} = 2.84$ to $T_{ON} = 1.86$ for $J_{ON} = 0.496 mA/\mu m^2$, whereas it reduces from $T_{ON} = 3.19$ to $T_{ON} = 2.10$ for $J_{ON} = 0.606 mA/\mu m^2$.

Figure 8 shows the modulus of the electric field component $|E|$, calculated by the BBPM-MoL along the structure at $\lambda_{SW} = 1.2894 \mu m$, in the passive case at temperature $T = 298 K$ a) and in the active one ((b) and (c)) with $J_{ON} = 0.606 mA/\mu m^2$ for two different values of the temperature: (b) $T = 298 K$ and (c) $T = 400 K$. The defective region is marked in red. Comparing Fig. 8(a) with Figs. 8(b) and (c) we can see that in the active cases, irrespective of the temperature, a strong localization of the electromagnetic field occurs in the defective region, thus leading to a strong amplification of the signal. Moreover, it is evident that in the output section $z = 132.072 \mu m$, the modulus of the electric field in the active cases assumes greater values with respect to that in the passive case. However, higher $|E|$ values occur for the active case at room temperature $T = 298 K$, for which we have calculated a transmittance $T_{ON} = 3.19$, whereas at $T = 400 K$ it assumes a value $T_{ON} = 1.95$.

The influence of the temperature on the performances of the active dilute nitride modulator under study are evaluated with the figure-of-merit changes with the temperature. Fig. 9 shows the behaviour of crosstalk as a function of temperature for the configuration of the modulator with (a) $J_{ON} = 0.496 mA/\mu m^2$ and (b) $J_{ON} = 0.606 mA/\mu m^2$. For both the configurations the best crosstalk occurs for temperature $T = 333 K$, for which we have calculated $CT = -14.8 dB$ for $J_{ON} = 0.496 mA/\mu m^2$ and $CT = -15.5 dB$ for $J_{ON} = 0.606 mA/\mu m^2$. We can observe that, for all the temperature values, the CT values of the modulator configuration with $J_{ON} = 0.606 mA/\mu m^2$ differ at about $-0.7 dB$ with respect to the ones with $J_{ON} = 0.496 mA/\mu m^2$. In fact, it is evident that best performances in terms of crosstalk can be obtained for the modulator configuration with $J_{ON} = 0.606 mA/\mu m^2$.

On the other hand, as shown in Fig. 10, that displays the contrast ratio as a function of the temperature for (a) $J_{ON} = 0.496 mA/\mu m^2$ and (b) $J_{ON} = 0.606 mA/\mu m^2$, the maximum CR value for both the modulator configurations can be obtained for $T = 333 K$. The calculated maximum

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**Figure 8.** Electric field component, calculated by the BBPM-MoL along the structure at $\lambda_{SW} = 1.2896 \mu m$, in the passive case (a) and in the active one ((b) and (c)) with $J_{ON} = 0.496 mA/\mu m^2$ for two different values of the temperature: (b) $T = 298 K$ and (c) $T = 400 K$. The defective region is marked in red.
contrast ratio is $CR = 30.1$ for $J_{ON} = 0.496 \text{mA/\mu m}^2$ and $CR = 35.4$ for $J_{ON} = 0.606 \text{mA/\mu m}^2$. However, to parity of temperature the configuration with greater current density value gives the best CR performances.

Finally, Fig. 11 reports the bandwidth $\Delta \lambda$ for which the crosstalk is less than $-12 \text{dB}$ around to $\lambda_{SW}$ as a function of temperature for (a) $J_{ON} = 0.496 \text{mA/\mu m}^2$ and for (b) $J_{ON} = 0.606 \text{mA/\mu m}^2$. In this case, for $J_{ON} = 0.496 \text{mA/\mu m}^2$ the bandwidth increases from $\Delta \lambda = 0.57 \text{nm}$ for $T = 298 \text{K}$ to $\Delta \lambda = 0.82 \text{nm}$ for $T = 360 \text{K}$, and then it decreases to $\Delta \lambda = 0.81 \text{nm}$ for $T = 400 \text{K}$. On the contrary, for the modulator configuration having $J_{ON} = 0.606 \text{mA/\mu m}^2$ the bandwidth assumes an increasing trend for all the temperature values ranging from $\Delta \lambda = 0.67 \text{nm}$ for $T = 298 \text{K}$ to $\Delta \lambda = 0.93 \text{nm}$ for $T = 400 \text{K}$.

The modulation depth, for all examined cases and all temperature values assumes a constant value $MD = 0.96$.

Figure 9. Pattern of the crosstalk CT as a function of the temperature for injection current density in the active case (a) $J_{ON} = 0.496 \text{mA/\mu m}^2$ and (b) $J_{ON} = 0.606 \text{mA/\mu m}^2$. The crosstalk has a minimum equal to $CT = -14.8 \text{dB}$ at $T = 333 \text{K}$ and $CT = -15.5 \text{dB}$ at $T = 333 \text{K}$ for $J_{ON} = 0.496 \text{mA/\mu m}^2$ and $J_{ON} = 0.606 \text{mA/\mu m}^2$, respectively.

Figure 10. Pattern of the contrast ratio CR as a function of the temperature for injection current density in the active case (a) $J_{ON} = 0.496 \text{mA/\mu m}^2$ and (b) $J_{ON} = 0.606 \text{mA/\mu m}^2$. The contrast ratio has a maximum equal to $CR = 30.1$ at $T = 333 \text{K}$ and $CR = 35.4$ at $T = 333 \text{K}$ for $J_{ON} = 0.496 \text{mA/\mu m}^2$ and $J_{ON} = 0.606 \text{mA/\mu m}^2$, respectively.
Figure 11. Pattern of the bandwidth $\Delta \lambda$ for CT $\leq -12$ dB as a function of the temperature for injection current density in the active case (a) $J_{ON} = 0.496$ mA/$\mu$m$^2$ and (b) $J_{ON} = 0.606$ mA/$\mu$m$^2$. In the case of $J_{ON} = 0.496$ mA/$\mu$m$^2$ the bandwidth maximum occurs for $T = 360$ K for which $\Delta \lambda = 0.82$ nm, while for the $J_{ON} = 0.606$ mA/$\mu$m$^2$ configuration the bandwidth assumes an increasing trend by increasing the temperature from $T = 298$ K to $T = 400$ K.

6. CONCLUSION

The temperature performance of dilute nitride photonic devices has been analysed, particularly focusing on photonic crystal waveguide modulators. Dilute nitride multi-quantum-well PBG structures have been investigated as active ON/OFF modulators at the wavelength $\lambda = 1.2896$ $\mu$m.

The proposed devices exhibit a maximum contrast ratio equal to CR = 30.1 for injected current density $J_{ON} = 0.496$ mA/$\mu$m$^2$ and CR = 35.4 for $J_{ON} = 0.606$ mA/$\mu$m$^2$. The minimum crosstalk is CT = -14.8 dB for $J_{ON} = 0.496$ mA/$\mu$m$^2$ and CT = -15.5 dB for $J_{ON} = 0.606$ mA/$\mu$m$^2$. Finally, the maximum bandwidth is $\Delta \lambda = 0.81$ nm for $J_{ON} = 0.496$ mA/$\mu$m$^2$ and $\Delta \lambda = 0.93$ nm for $J_{ON} = 0.606$ mA/$\mu$m$^2$. The temperature performance of the proposed device shows a good stability in the range $T = 298$ K–400 K. In particular, the CT varies of about 1.2 dB in the whole temperature range, whereas CR and $\Delta \lambda$ experience, respectively, a maximum variation of 25% and 30% of their maximum values. The achieved temperature stability range is comparable with the ones demonstrated, either theoretically or experimentally, in the literature for QW lasers based on dilute nitrides [9–13]. Moreover, the advantage of the proposed design, with respect to passive modulators, is to achieve an ON-OFF switching functionality together with an efficient signal amplification and a stable temperature operation.

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APPENDIX A.

The material parameters of the constituent binaries of GaInAs and GaInNAs are tabulated in the table below. The relevant values for the ternary and quaternaries are obtained using the interpolation
formulas:
\[
P(A_xB_{1-x}C_yD_{1-y}) = xyP(AC) + (1-x)(1-y)P(BD) + (1-x)yP(BC) + x(1-y)P(AD) \\
P(A_xB_{1-x}C) = xP(AC) + +(1-x)P(BC)
\]

| Material parameters used in the calculations [44] |
|-----------------|-----------------|-----------------|-----------------|
| **Materials**   | GaAs | InAs | InN | GaN |
| \(\alpha_o\) (Å) | 5.6533 | 6.0584 | 4.98 | 4.5 |
| \(\alpha_c\) (eV) | 1.16 | 1.00 | 1.5 | 1.27 |
| \(\alpha_v\) (eV) | -7.17 | -5.08 | -1.85 | -2.2 |
| \(b\) (eV) | -1.7 | -1.8 | -1.2 | -1.7 |
| \(C_{11}\) \((\times 10^{10} \text{N/m}^2)\) | 11.879 | 8.329 | 18.7 | 29.3 |
| \(C_{12}\) \((\times 10^{10} \text{N/m}^2)\) | 5.376 | 4.526 | 12.5 | 15.9 |
| \(\gamma_1\) | 6.8 | 20.4 | 1.92 | 2.67 |
| \(\gamma_2\) | 1.9 | 8.3 | 0.47 | 0.75 |
| \(\gamma_3\) | 2.73 | 9.1 | 0.85 | 1.10 |
| \(E_p\) (eV) | 28.8 | 21.5 | 25 | 25 |

where, \(\alpha_o\): lattice constant, \(\alpha_c\): hydrostatic deformation potential, conduction band, \(\alpha_v\): hydrostatic deformation potential, valence band, \(b\): shear deformation potential, \(C_{11,12}\): elastic stiffness constant, \(\gamma_{1,2,3}\): Luttinger-Kohn parameters, \(E_p\): optical matrix parameter.

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